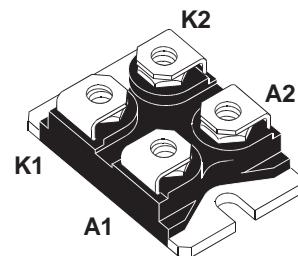
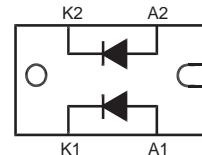


**STPS80L15TV**

## LOW DROP OR-ing POWER SCHOTTKY DIODE

### MAIN PRODUCT CHARACTERISTICS

I <sub>F(AV)</sub>	2 x 40 A
V <sub>RRM</sub>	15 V
T <sub>j(max)</sub>	125 °C
V <sub>F(max)</sub>	0.33 V



ISOTOP™

### FEATURES AND BENEFITS

- VERY LOW DROP FORWARD VOLTAGE FOR LESS POWER DISSIPATION AND REDUCED HEATSINK
- INSULATED PACKAGE:  
Insulated voltage = 2500 V<sub>(RMS)</sub>  
Capacitance = 45 pF

### DESCRIPTION

Dual Schottky rectifier suited for Switched Mode Power Supplies and DC to DC power converters.

Packaged in ISOTOP™, this device is especially intended for use as an OR-ing diode in fault tolerant power supply equipments.

### ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	15	V
I <sub>F(RMS)</sub>	RMS forward current	100	A
I <sub>F(AV)</sub>	Average forward current	40	A
I <sub>FSM</sub>	Surge non repetitive forward current	700	A
I <sub>RRM</sub>	Repetitive peak reverse current	2	A
T <sub>stg</sub>	Storage temperature range	- 65 to + 150	°C
T <sub>j</sub>	Maximum operating junction temperature	125	°C
dV/dt	Critical rate of rise of reverse voltage	10000	V/μs

\* :  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th}(j-a)}$  thermal runaway condition for a diode on its own heatsink

**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
R <sub>th</sub> (j-c)	Junction to case	Per diode	1
		Total	0.55
R <sub>th</sub> (c)		Coupling	0.1

**STATIC ELECTRICAL CHARACTERISTICS (per diode)**

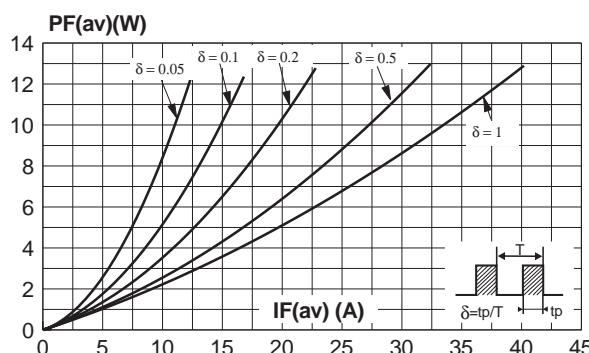
Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I <sub>R</sub> *	Reverse leakage current	T <sub>j</sub> = 100°C	V <sub>R</sub> = 5V		280		mA
		T <sub>j</sub> = 25°C	V <sub>R</sub> = 12V			11	
		T <sub>j</sub> = 100°C			0.44	1.1	A
V <sub>F</sub> *	Forward voltage drop	T <sub>j</sub> = 25°C	I <sub>F</sub> = 40 A			0.43	V
		T <sub>j</sub> = 125°C	I <sub>F</sub> = 40 A		0.28	0.33	

Pulse test : \* tp = 380 µs, δ < 2 %

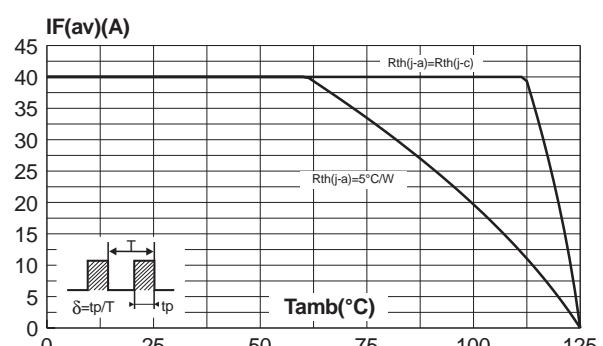
To evaluate the conduction losses use the following equation :

$$P = 0.19 \times I_{F(AV)} + 3.25 \times 10^{-3} \times I_{F(RMS)}^2$$

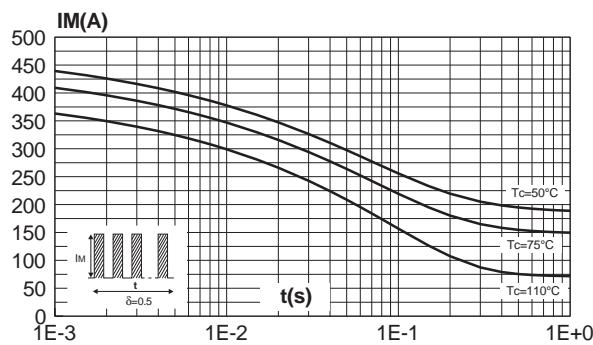
**Fig. 1:** Average forward power dissipation versus average forward current (per diode).



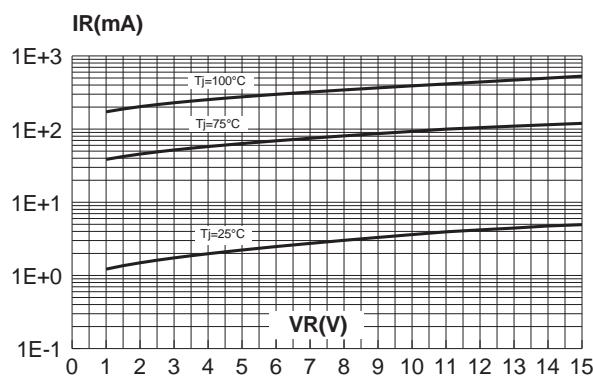
**Fig. 2:** Average forward current versus ambient temperature ( $\delta=1$ , per diode).



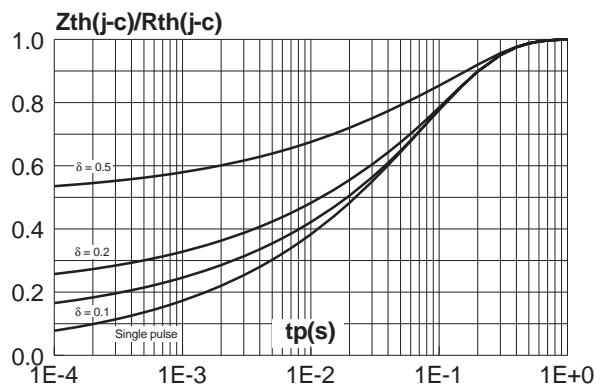
**Fig. 3:** Non repetitive surge peak forward current versus overload duration (maximum values, per diode).



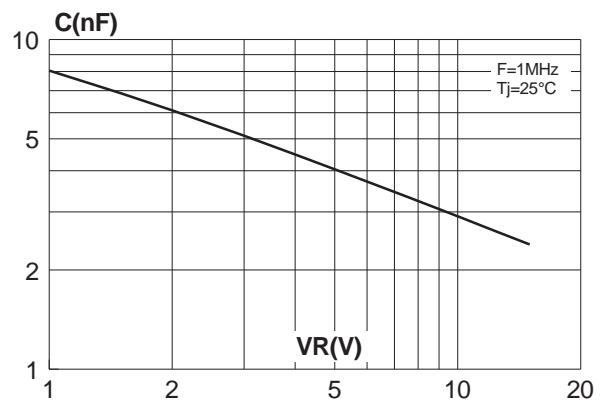
**Fig. 5:** Reverse leakage current versus reverse voltage applied (typical values, per diode).



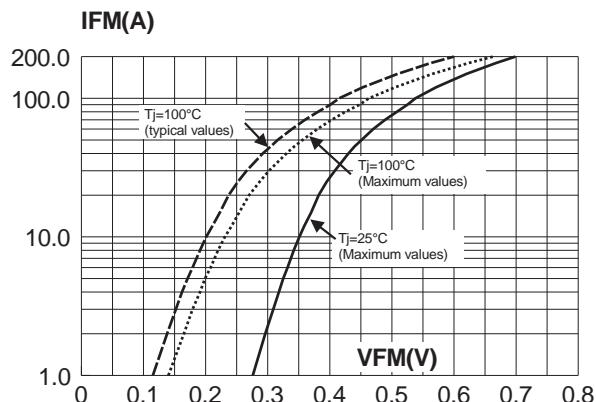
**Fig. 4:** Relative variation of thermal impedance junction to case versus pulse(per diode).



**Fig. 6:** Junction capacitance versus reverse voltage applied (typical values, per diode).



**Fig. 7:** Forward voltage drop versus forward current (per diode).



## STPS80L15TV

### PACKAGE MECHANICAL DATA ISOTOP

REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	11.80	12.20	0.465	0.480
A1	8.90	9.10	0.350	0.358
B	7.8	8.20	0.307	0.323
C	0.75	0.85	0.030	0.033
C2	1.95	2.05	0.077	0.081
D	37.80	38.20	1.488	1.504
D1	31.50	31.70	1.240	1.248
E	25.15	25.50	0.990	1.004
E1	23.85	24.15	0.939	0.951
E2	24.80 typ.		0.976 typ.	
G	14.90	15.10	0.587	0.594
G1	12.60	12.80	0.496	0.504
G2	3.50	4.30	0.138	0.169
F	4.10	4.30	0.161	0.169
F1	4.60	5.00	0.181	0.197
P	4.00	4.30	0.157	0.69
P1	4.00	4.40	0.157	0.173
S	30.10	30.30	1.185	1.193

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS80L15TV	STPS80L15TV	ISOTOP	28g (without screws)	10	Tube

- Cooling method: by conduction (C)
- Recommended torque value: 1.3 N.m.
- Maximum torque value: 1.5 N.m.
- Epoxy meets UL94,V0

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied.

STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

© 1999 STMicroelectronics - Printed in Italy - All rights reserved.

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - China - Finland - France - Germany - Hong Kong - India - Italy - Japan - Malaysia  
Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - U.S.A.

<http://www.st.com>